

# POWER RELAY

## 1 POLE—8 A (MEDIUM LOAD CONTROL)

### JS SERIES

**Lead Free / RoHS compliant\***

#### ■ FEATURES

- UL, CSA, VDE, SEV, SEMKO, FIMKO, ÖVE, BSI recognized
- UL class B (130°C) insulation
- 1 form A (SPST-NO) or 1 form C (SPDT) contact
- Low profile and space saving—Height: 12.5 mm  
—Mounting space: 290 mm<sup>2</sup>
- High sensitivity in small package  
—Operating power ..... 0.11 to 0.14 W  
—Nominal power ..... 0.22 to 0.29 W
- High isolation in small package  
—Insulation distance : 8 mm  
—Dielectric strength : 5,000 VAC (between coil and contacts)  
—Surge strength : 10,000 V
- Plastic materials—UL 94 flame class V-0  
—UL CTI level class 2
- Plastic sealed type
- Lead Free since date code: 0438B9, 0434R - Please see page 6 for more information

\* some part numbers still contain cadmium and are not RoHS compliant



#### ■ ORDERING INFORMATION

[Example]      JS - 12 M E - K T - V3  
                   (a) (\*) (b) (c) (d) (e) (f) (j)

(a)	Series Name	JS : JS Series
(b)	Nominal Voltage	Refer to the COIL DATA CHART
(c)	Contact Arrangement	Nil: 1 form C (SPDT)
(d)	Contact Material	N : Silver tin oxide gold overlay
(e)	Enclosure	K : Plastic sealed type
(f)	Construction	Nil: 3.2 mm
(j)	For low current application	Nil: 0.3μ gold overlay (available with Nil, N and F contact)

Note: Actual marking omits the hyphen (-) of (\*)

# JS SERIES

## ■ SAFETY STANDARD AND FILE NUMBERS

UL508, 873 (File No. E56140, E108658)

C22.2 No. 14 (File No. LR35579)

VDE 0435, 0631, 0700 (File No. 11039-4940-1010)

Nominal voltage	Contact rating
5 to 60 VDC	1/3 HP 125 VAC, 1/2 HP 250 VAC 10 A 30 VDC/250 VAC, resistive 3A 250 VAC inductive (PF = 0.4) Pilot duty B 300, C150

## ■ SPECIFICATIONS

Contact material Silver Tin Oxide (AgSnO<sub>2</sub>) type: N type

Item	JS ( )N-K	JS ( )MN-K	JS ( )MN-KT
Contact	Arrangement	1 Form C	1 Form A
	Material	Au+AgSnO <sub>2</sub>	
	Resistance (initial)	Max. 100 ohms (at 1A 6 VDC)	
	Rating	8A 250 VAC / 24 VDC	
	Max. carrying current	10A	
	Max. switching power	2,000VA/192W	
	Max. switching voltage	150VDC/400VAC	
	Min. switching load	10mA 5VDC	
	Max. switching current	10A	
Coil	Operating temperature	-40° C to +85° C (no frost)	
Time value	Operate	Max. 10ms (at nominal voltage, without bounce)	
	Release (without diode)	Max. 5ms (at nominal voltage, without bounce)	
Insulation	Resistance (at 500VDC)	Min. 1,000 Mohms	
	Dielectric Strength	B/T contacts	1,000VAC, 1 minute
		B/T coil and contacts	4,000VAC, 1 minute
Surge strength	10,000V (at 1.2x50 μsec.)		
Life	Mechanical	20x10 <sup>6</sup> operations minimum	
	Electrical (resistive load)	50x10 <sup>3</sup> ops. min.	100x10 <sup>3</sup> ops. min.
Vibration resistance	Misoperation	10 to 55 Hz at double amplitude of 1.65mm	
	Endurance	10 to 55 Hz at double amplitude of 3.3mm	
Shock resistance	Misoperation	Min. 200m/s <sup>2</sup> (11±1ms)	
	Endurance	Min. 1,000m/s <sup>2</sup> (6±1ms)	
Weight	Approx. 8g		

\*1 Minimum switching loads mentioned above are reference values. Please perform the confirmation test with the actual load before production since reference values may vary according to switching frequencies, environmental conditions and expected reliability levels. 2

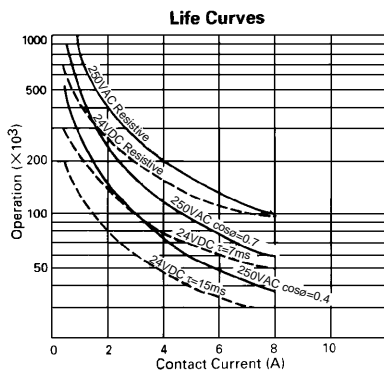
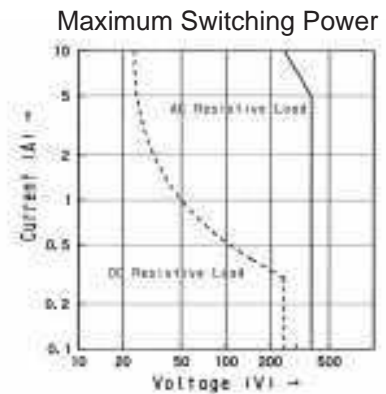
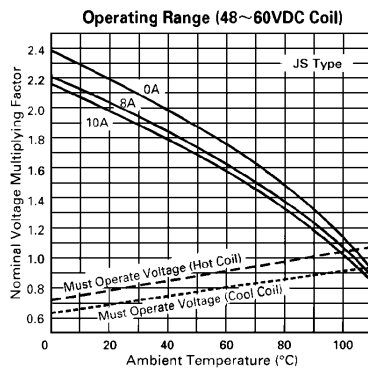
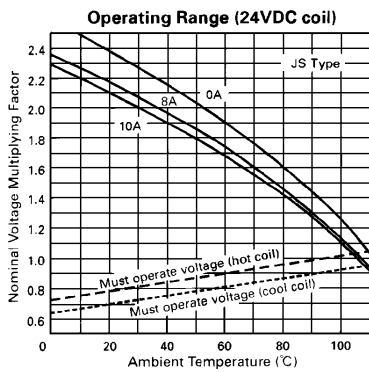
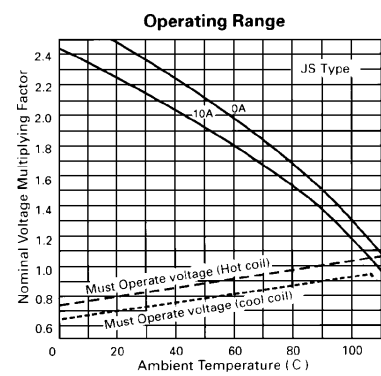
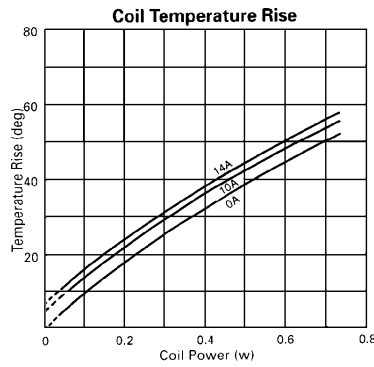
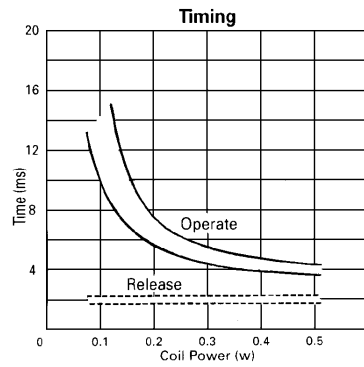
# JS SERIES

## COIL DATA CHART

MODEL	Nominal voltage	Coil resistance ( $\pm 10\%$ )	Must operate voltage	Must release voltage	Nominal power
JS- 5(M)(NIL,E,N,D,F)-K(T)	5 VDC	112 $\Omega$	3.5 VDC	0.5 VDC	225 mW
JS- 6(M)(NIL,E,N,D,F)-K(T)	6 VDC	160 $\Omega$	4.2 VDC	0.6 VDC	225 mW
JS- 9(M)(NIL,E,N,D,F)-K(T)	9 VDC	360 $\Omega$	6.3 VDC	0.9 VDC	225 mW
JS-12(M)(NIL,E,N,D,F)-K(T)	12 VDC	660 $\Omega$	8.5 VDC	1.2 VDC	220 mW
JS-18(M)(NIL,E,N,D,F)-K(T)	18 VDC	1,455 $\Omega$	12.7 VDC	1.8 VDC	225 mW
JS-24(M)(NIL,E,N,D,F)-K(T)	24 VDC	2,350 $\Omega$	16.8 VDC	2.4 VDC	245 mW
JS-48(M)(NIL,E,N,D,F)-K(T)	48 VDC	8,000 $\Omega$	33.4 VDC	4.8 VDC	290 mW
JS-60(M)(NIL,E,N,D,F)-K(T)	60 VDC	12,500 $\Omega$	41.7 VDC	6.0 VDC	290 mW

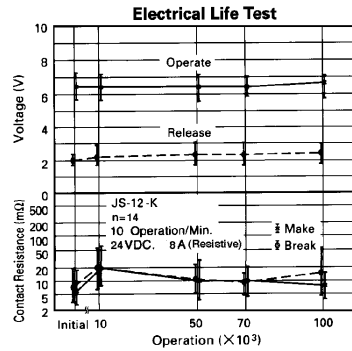
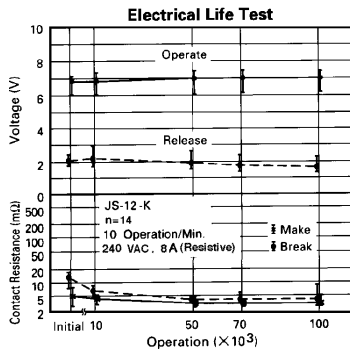
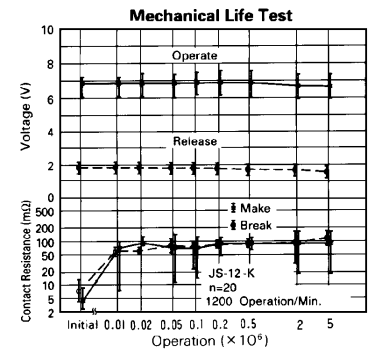
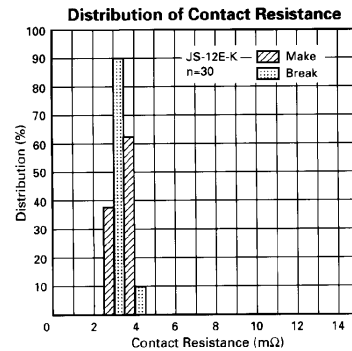
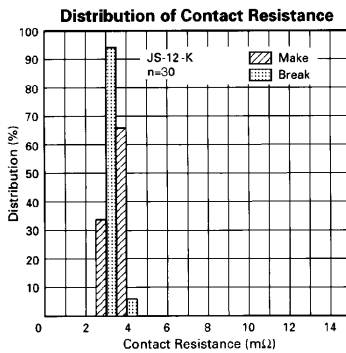
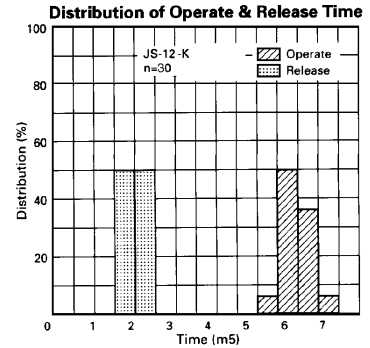
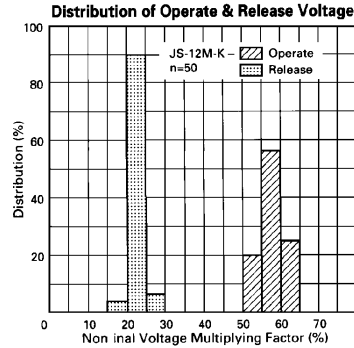
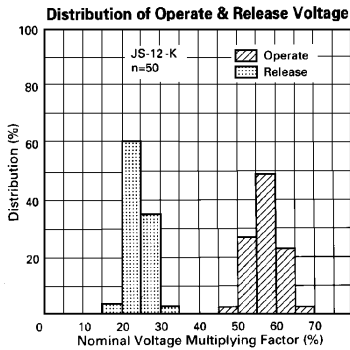
Note : All values in the table are measured at 20°C.

## CHARACTERISTIC DATA



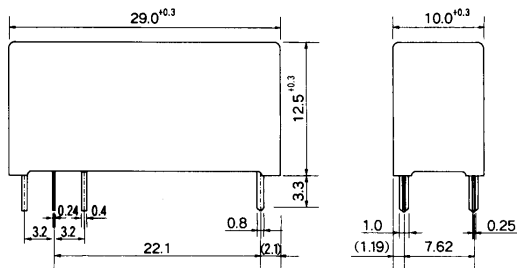
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## REFERENCE DATA

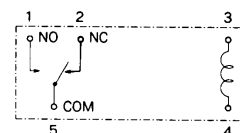


## DIMENSIONS

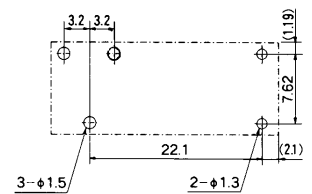
### Dimensions



### Schematics (BOTTOM VIEW)



### PC board mounting hole layout (BOTTOM VIEW)



JS-K type

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# JS SERIES

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## RoHS Compliance and Lead Free Relay Information

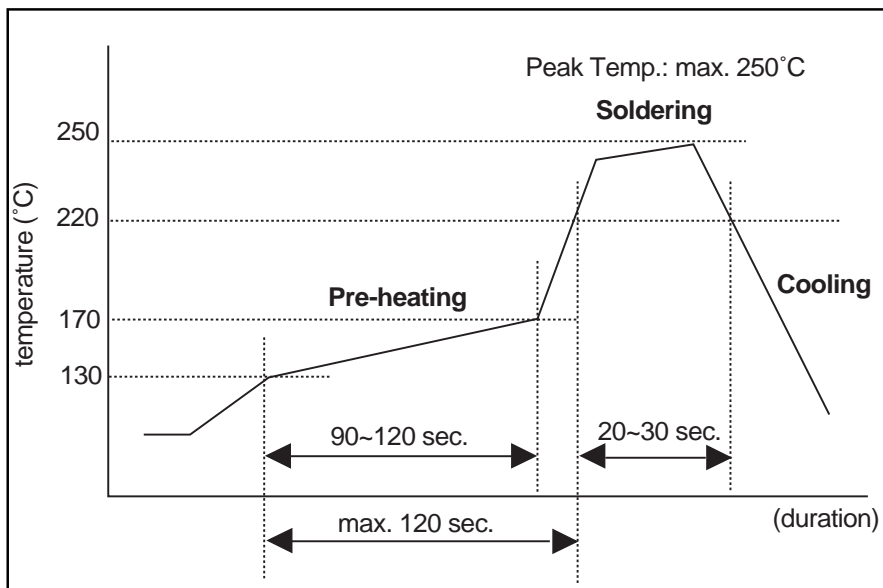
### 1. General Information

- Relays produced after the specific date code that is indicated on each data sheet are lead-free now. Most of our signal and power relays are lead-free. Please refer to Lead-Free Status Info. (<http://www.fcai.fujitsu.com/pdf/LeadFreeLetter.pdf>)
- Lead free solder paste currently used in relays is Sn-3.0Ag-0.5Cu. From February 2005 forward Sn-3.0Cu-Ni will be used for FTRB3 and FTR-B4 series relays.
- Most signal and some power relays also comply with RoHS. Please refer to individual data sheets. Relays that are RoHS compliant do not contain the 6 hazardous materials that are restricted by RoHS directive (lead, mercury, cadmium, chromium IV, PBB, PBDE).
- It has been verified that using lead-free relays in lead assembly process will not cause any problems (compatible).
- "LF" is marked on each outer and inner carton. (No marking on individual relays).
- To avoid leaded relays (for lead-free sample, etc.) please consult with area sales office. We will ship leaded relays as long as the leaded relay inventory exists.

### 2. Recommended Lead Free Solder Profile

- Recommended solder paste Sn-3.0Ag-0.5Cu and Sn-3.0 Cu-Ni (only FTR-B3 and FTR-B4 from February 2005)

#### Reflow Solder condition



#### Flow Solder condition:

Pre-heating: maximum 120°C  
Soldering: dip within 5 sec. at 260°C solder bath

#### Solder by Soldering Iron:

Soldering Iron  
Temperature: maximum 360°C  
Duration: maximum 3 sec.

**We highly recommend that you confirm your actual solder conditions**

### 3. Moisture Sensitivity

- Moisture Sensitivity Level standard is not applicable to electromechanical relays.

### 4. Tin Whisker

- SnAgCu solder is known as low risk of tin whisker. No considerable length whisker was found by our in-house test.

### 5. Solid State Relays

- Each lead terminal will be changed from solder plating to Sn plating and Nickel plating. A layer of Nickel plating is between the terminal and the Sn plating to avoid whisker.